Designer's™ Data Sheet

SWITCHMODE[™] NPN Bipolar Power Transistor For Switching Power Supply Applications

The BUL146/BUL146F have an applications specific state–of–the–art die designed for use in fluorescent electric lamp ballasts to 130 Watts and in Switchmode Power supplies for all types of electronic equipment. These high voltage/high speed transistors offer the following:

- Improved Efficiency Due to Low Base Drive Requirements:
- High and Flat DC Current Gain
- Fast Switching
- No Coil Required in Base Circuit for Turn-Off (No Current Tail)
- Full Characterization at 125°C
- Parametric Distributions are Tight and Consistent Lot-to-Lot
- Two Package Choices: Standard TO-220 or Isolated TO-220
- BUL146F, Isolated Case 221D, is UL Recognized to 3500 V_{RMS}: File #E69369

MAXIMUM RATINGS

Rating	Symbol	BUL146	BUL146F	Unit				
Collector–Emitter Sustaining Voltage	VCEO	4(Vdc					
Collector–Emitter Breakdown Voltage	VCES	70	Vdc					
Emitter-Base Voltage	VEBO	9	Vdc					
Collector Current — Continuous — Peak(1)	IС IСМ	6 1	Adc					
Base Current — Continuous — Peak(1)	I _B I _{BM}	4.	-	Adc				
$ \begin{array}{ll} \mbox{RMS Isolated Voltage(2)} & \mbox{Test No. 1 Per Fig. 22a} \\ \mbox{(for 1 sec, R.H. < 30\%,} & \mbox{Test No. 2 Per Fig. 22b} \\ \mbox{T}_{C} = 25^{\circ}\mbox{C} & \mbox{Test No. 3 Per Fig. 22c} \\ \end{array} $	VISOL		4500 3500 1500	V				
Total Device Dissipation $(T_C = 25^{\circ}C)$ Derate above 25^{\circ}C	PD	100 0.8	40 0.32	Watts W/°C				
Operating and Storage Temperature	TJ, Tstg	– 65 t	°C					
THERMAL CHARACTERISTICS								

Rating	Symbol	BUL44	BUL44F	Unit
Thermal Resistance — Junction to Case — Junction to Ambient	R _θ JC R _θ JA	1.25 62.5	3.125 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	TL	26	60	°C

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit		
OFF CHARACTERISTICS							
Collector–Emitter Sustaining Voltage (I_C = 100 mA, L = 25 mH)	V _{CEO(sus)}	400	—	—	Vdc		
Collector Cutoff Current (V_{CE} = Rated V_{CEO} , I_B = 0)	ICEO	—	—	100	μAdc		
Collector Cutoff Current (V_{CE} = Rated V_{CES} , V_{EB} = 0)	ICES	_	—	100	μAdc		
(T _C = 125°C)		—	—	500			
$(V_{CE} = 500 \text{ V}, \text{ V}_{EB} = 0)$ $(T_{C} = 125^{\circ}\text{C})$	1	I —	I —	100			

Emitter Cutoff Current (V_{EB} = 9.0 Vdc, I_{C} = 0)

(1) Pulse Test: Pulse Width = 5.0 ms, Duty Cycle \leq 10%.

(2) Proper strike and creepage distance must be provided.

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Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

IEBC

Preferred devices are Motorola recommended choices for future use and best overall value.





100

μAdc

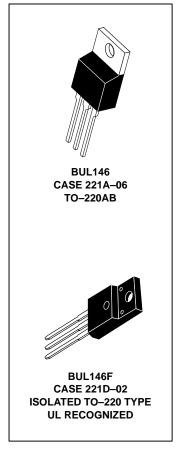
(continued)

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*Motorola Preferred Device

POWER TRANSISTOR 6.0 AMPERES 700 VOLTS 40 and 100 WATTS



Characteristic					Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS						•	•		
Base–Emitter Saturation	VBE(sat)	_	0.82 0.93	1.1 1.25	Vdc				
$(I_{C} = 3.0 \text{ Adc}, I_{B} = 0.6 \text{ Adc})$ Collector–Emitter Saturation Voltage (I_{C} = 1.3 \text{ Adc}, I_{B} = 0.13 \text{ Adc}) (T_{C} = 125°C) (I_{C} = 3.0 \text{ Adc}, I_{B} = 0.6 \text{ Adc}) (T_{C} = 125°C)					VCE(sat)	 	0.22 0.20 0.30 0.30	0.5 0.5 0.7 0.7	Vdc
$\begin{array}{c} (T_{C} = 125 \text{ C}) \\ \hline \text{DC Current Gain} & (I_{C} = 0.5 \text{ Adc}, \text{ V}_{CE} = 5.0 \text{ Vdc}) \\ & (I_{C} = 1.3 \text{ Adc}, \text{ V}_{CE} = 1.0 \text{ Vdc}) \\ & (I_{C} = 3.0 \text{ Adc}, \text{ V}_{CE} = 1.0 \text{ Vdc}) \\ & (I_{C} = 10 \text{ mAdc}, \text{ V}_{CE} = 5.0 \text{ Vdc}) \\ & (T_{C} = 125^{\circ}\text{C}) \\ & (T_{C} = 125^{\circ}\text{C}) \\ \end{array}$					hFE	14 — 12 12 8.0 7.0 10	— 30 20 13 12 20	34 — — — — —	_
DYNAMIC CHARACTER						1			
Current Gain Bandwidth				1.0 MHz)	fT		14	—	MHz
Output Capacitance (VC	CB = 10	0 Vdc, I _E = 0, f = 1.0	0 MHz)		COB	—	95	150	pF
Input Capacitance (VEB	= 8.0	V)			CIB	—	1000	1500	pF
Dynamic Saturation Volt	age:	(I _C = 1.3 Adc I _{B1} = 300 mAdc	1.0 μs	(T _C = 125°C)		_	2.5 6.5	_	· V
Determined 1.0 μs an 3.0 μs respectively at	fter	$V_{CC} = 300 \text{ V}$	3.0 µs	(T _C = 125°C)	VCE(dsat)		0.6 2.5		
rising I _{B1} reaches 90 ^c final I _{B1} (see Figure 18)	% of	of (IC = 3.0 Adc IB1 = 0.6 Adc VCC = 300 V)	1.0 µs	(T _C = 125°C)	VCE(dsat)	_	3.0 7.0	_	
(see Figure 10)			3.0 μs	(T _C = 125°C)		—	0.75 1.4	_	
SWITCHING CHARACTE	RISTI	CS: Resistive Loa	d (D.C. ≤	10%, Pulse Wid	th = 20 μs)		-		
Turn–On Time	$(I_{C} = 1.3 \text{ Adc}, I_{B1} = 0.13 \text{ Adc}$ $I_{B2} = 0.65 \text{ Adc}, V_{CC} = 300 \text{ V})$ $(T_{C} = 125^{\circ}\text{C})$ $(T_{C} = 125^{\circ}\text{C})$			ton	_	100 90	200 —	ns	
Turn–Off Time				(T _C = 125°C)	toff	—	1.35 1.90	2.5 —	μs
Turn–On Time	$(I_C = 3.0 \text{ Adc}, I_{B1} = 0.6 \text{ Adc})$ $I_{B1} = 1.5 \text{ Adc}, V_{CC} = 300 \text{ V})$ $(T_C = 125^{\circ}\text{C})$				ton	_	90 100	150 —	ns
Turn–Off Time	(T _C = 125°C)				toff	_	1.7 2.1	2.5 —	μs
SWITCHING CHARACTE	RISTI	CS: Inductive Loa	d (V _{clam}	_p = 300 V, V _{CC} =	= 15 V, L = 200 μH	H)			
Fall Time	(I _C = 1.3 Adc, I _{B1} = 0.13 Adc			(T _C = 125°C)	t _{fi}		115 120	200 —	ns
Storage Time	(T _C = 125°C) (T _C = 125°C)				t _{si}	_	1.35 1.75	2.5 —	μs
Crossover Time					t _c		200 210	350 —	ns
Fall Time	$(I_{C} = 3.0 \text{ Adc}, I_{B1} = 0.6 \text{ Adc}$ $I_{B2} = 1.5 \text{ Adc})$ $(T_{C} = 125^{\circ}\text{C})$ $(T_{C} = 125^{\circ}\text{C})$				t _{fi}		85 100	150 —	ns
Storage Time					t _{Si}	—	1.75 2.25	2.5 —	μs
Crossover Time				(T _C = 125°C)	t _C	_	175 200	300 —	ns
Fall Time	$(I_C = 3.0 \text{ Adc}, I_{B1} = 0.6 \text{ Adc}$ $I_{B2} = 0.6 \text{ Adc}$ $(T_C = 125^{\circ}\text{C})$				t _{fi}	80 —	 210	180 —	ns
Storage Time	(T _C = 125°C) (T _C = 125°C)				t _{si}	2.6 —	— 4.5	3.8 —	μs
Crossover Time					t _C	—	230 400	350 —	ns

TYPICAL STATIC CHARACTERISTICS

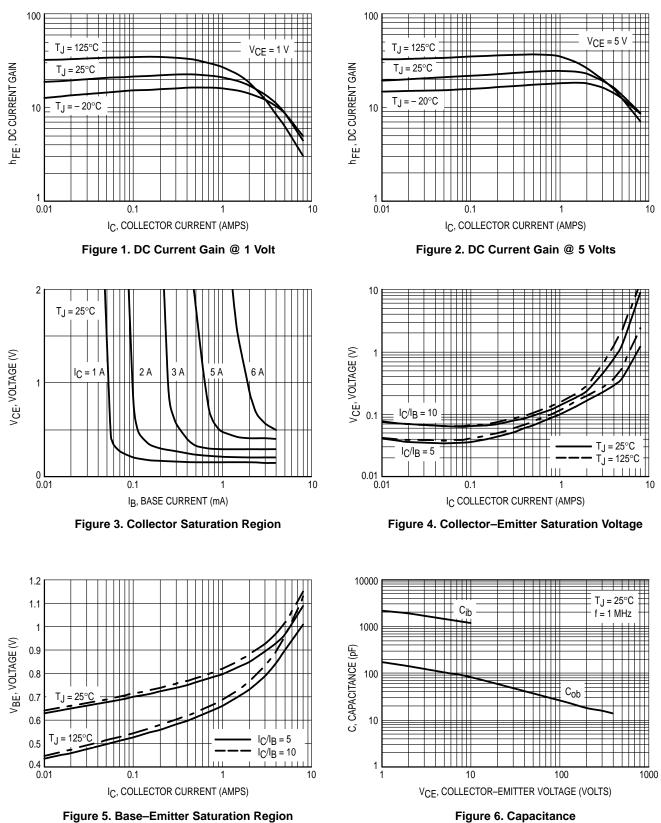
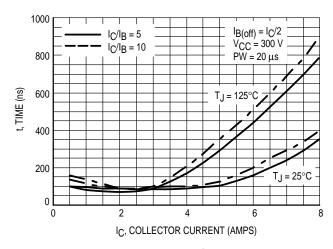


Figure 5. Base–Emitter Saturation Region

3



TYPICAL SWITCHING CHARACTERISTICS $(I_{B2} = I_C/2 \text{ for all switching})$

Figure 7. Resistive Switching, ton

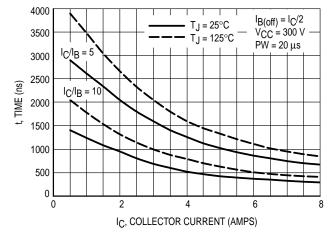


Figure 8. Resistive Switching, toff

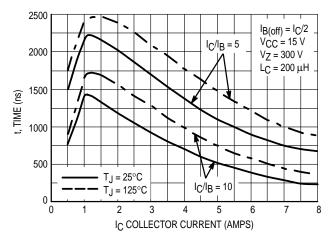
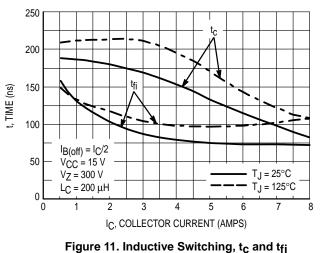


Figure 9. Inductive Storage Time, tsi



IC/IB = 5

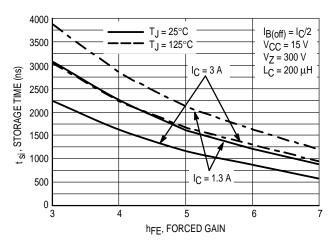
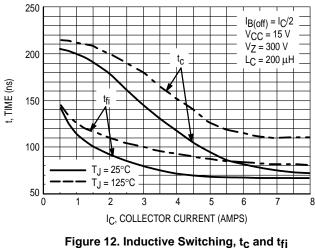
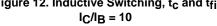
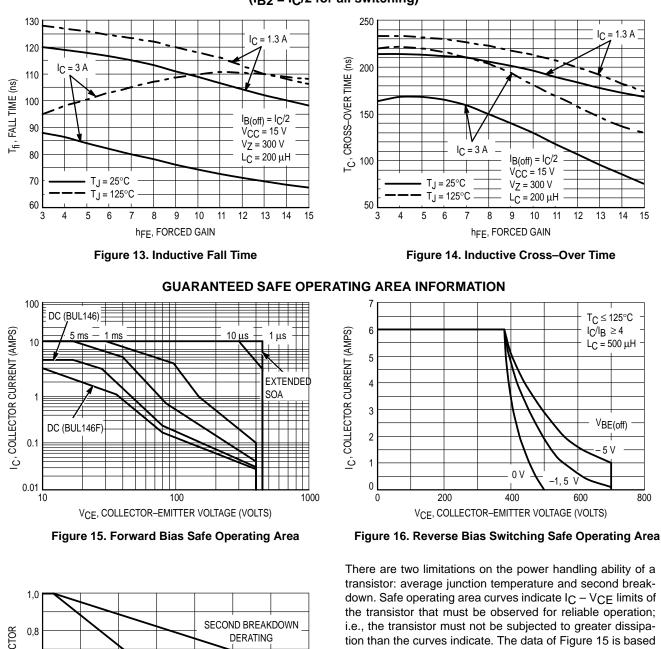


Figure 10. Inductive Storage Time, tsi(hFE)





Motorola Bipolar Power Transistor Device Data



TYPICAL SWITCHING CHARACTERISTICS (IB2 = IC/2 for all switching)

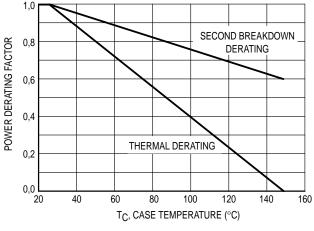


Figure 17. Forward Bias Power Derating

transistor: average junction temperature and second breakdown. Safe operating area curves indicate IC - VCE limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 15 is based on $T_C = 25^{\circ}C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C > 25^{\circ}C$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown in Figure 15 may be found at any case temperature by using the appropriate curve on Figure 17. TJ(pk) may be calculated from the data in Figure 20 and 21. At any case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn-off with the base-to-emitter junction reverse-biased. The safe level is specified as a reverse-biased safe operating area (Figure 16). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.

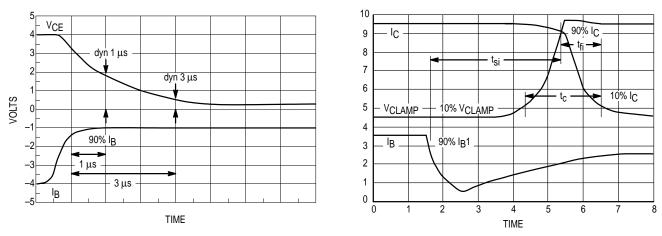


Figure 18. Dynamic Saturation Voltage Measurements



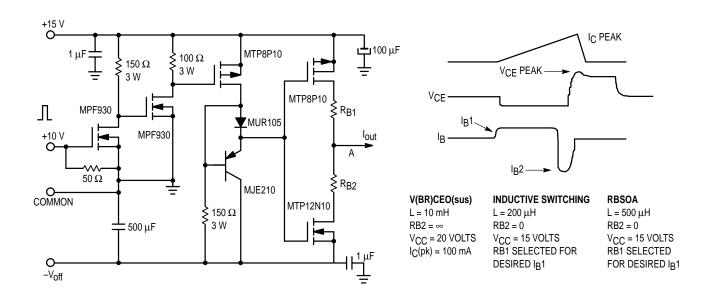
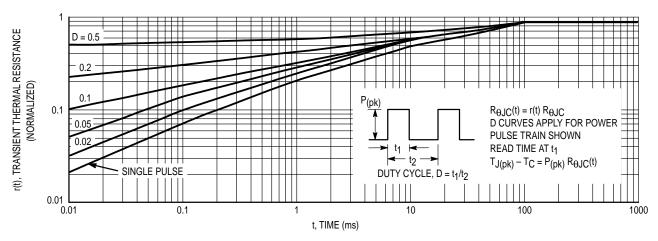


Table 1. Inductive Load Switching Drive Circuit

TYPICAL THERMAL RESPONSE





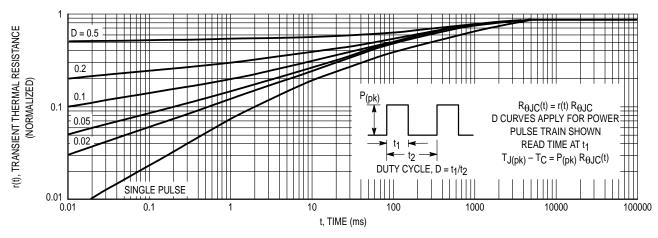
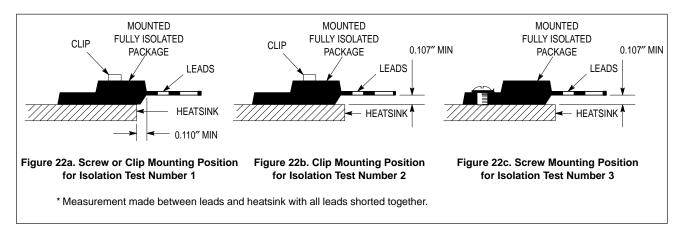
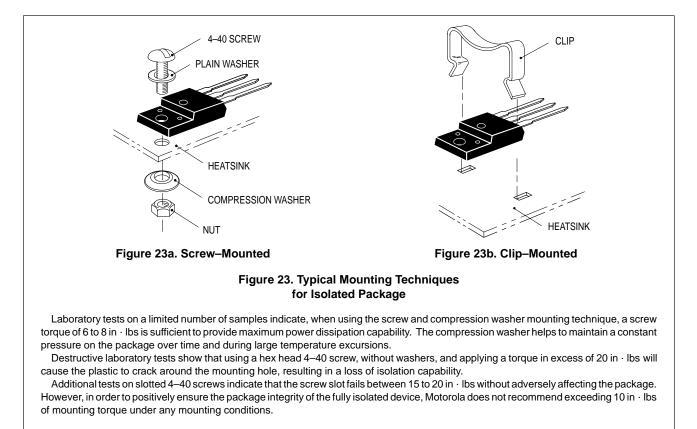


Figure 21. Typical Thermal Response ($Z_{\theta JC}(t)$) for BUL146F

TEST CONDITIONS FOR ISOLATION TESTS*

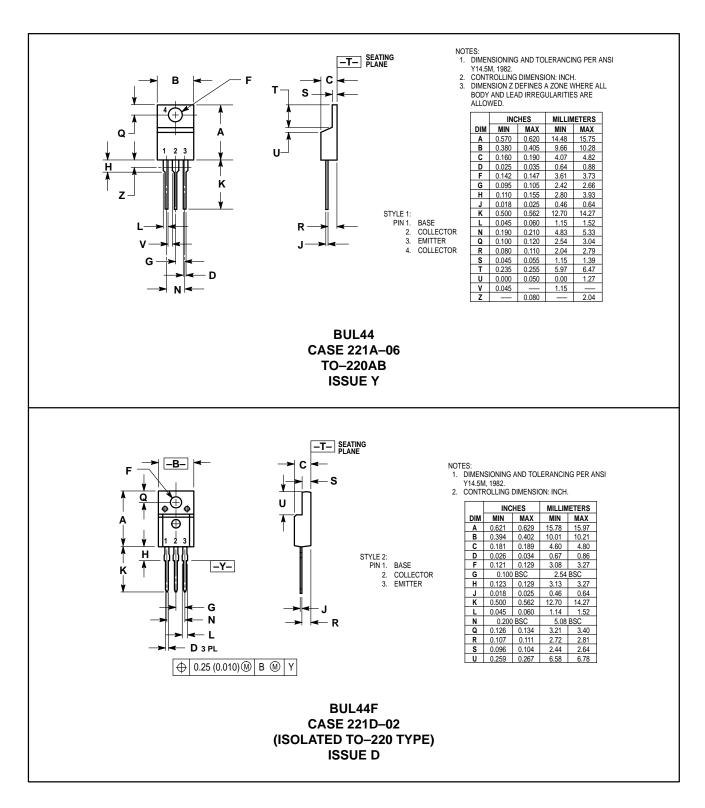


MOUNTING INFORMATION**



** For more information about mounting power semiconductors see Application Note AN1040.

PACKAGE DIMENSIONS

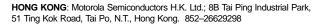


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